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**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re U.S. Patent Application of

YASUI et al.

Application Number: 09/910,904

Filed: July 24, 2001

For: PLANARIZING METHOD OF SEMICONDUCTOR  
WAFER AND APPARATUS THEREOF

Attorney Docket No. ASAM.0012

Art Unit 1765

Examiner:

Umez Eronini, Lynette

Honorable Assistant Commissioner  
for Patents  
Washington, D.C. 20231

**RECEIVED**

**AUG 12 2003**

**TC 1700**

**COVER LETTER**

Sir:

[ ] The fee for submission of additional claims is calculated as shown below:

FOR	TOTAL WITH NEW CLAIMS ADDED	TOTAL CURRENTLY ON FILE	CLAIMS PAID	RATE	CALCULATION
Total Claims	22	22	2 (Over 20)	x \$18	0
Independent Claims	5	5	2 (Over 3)	x \$84	0
MULTIPLE DEPENDENT CLAIM(S)				+ \$280	0
REDUCTION FOR FILING BY SMALL ENTITY (note 37 C.F.R. §§ 1.9, 1.27, 1.28). IF APPLICABLE, VERIFIED STATEMENT MUST BE ATTACHED				x ½	
			TOTAL		0.00

In addition, the below-identified communications are submitted in the above-captioned application or proceeding:

[ x ] Response to Office Action  
(with Claim Amendments)

[ ] Substitute Specification

[ ] Preliminary Amendment

[ ] Other \_\_\_\_\_

[ ] Petition for Extension of Time (\_\_\_ month)

[ ] Terminal Disclaimer

[ ] Letter to Draftsperson

[ ] Assignment

[ ] Petition under \_\_\_\_\_

- ☐ Please charge my **Deposit Account Number** \_\_\_\_\_ in the amount of \_\_\_\_\_ to cover the fees for \_\_\_\_\_. A duplicate copy of this paper is enclosed.
- ☐ A check in the amount of \$\_\_\_\_\_ to cover the fee is enclosed.
- ☒ The Commissioner is hereby authorized to charge any additional fees associated with this communication, including patent application filing fees and processing fees under 37 C.F.R. § 1.16 and 1.17, or credit any overpayment to **Deposit Account Number 08-1480**.

Respectfully submitted,

\_\_\_\_\_  
Stanley P. Fisher

Registration Number 24,344

  
\_\_\_\_\_  
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**August 11, 2003**



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8/14/03

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**RESPONSE AND AMENDMENT UNDER 37 C.F.R. § 1.111**

**Sir:**

This is in response to the Office Action mailed on May 9, 2003, the period of response to which is set to expire on August 9, 2003. Please amend the above-referenced application as follows: